

What is claimed is:

1. A substrate having a repaired metallic pattern whose defective part is repaired by applying a conductive material thereon, wherein the defective part is repaired by a thin film of metal deposited from a metallic organic compound.

2. A substrate having a repaired metallic pattern according to claim 1, wherein said metallic pattern is an electrode.

3. A substrate having a repaired metallic pattern according to claim 1, wherein said metallic pattern is a lightproof film.

4. A substrate having a repaired metallic pattern according to any one of claim 1 to claim 3, wherein said metallic organic compound is gold-resinate-base paste for low temperature baking.

5. A method for repairing a metallic pattern on a substrate, said method comprising steps of:

applying a metallic organic compound to a defective part in a metallic pattern formed on said substrate; and

heating said organic compound to deposit a metallic thin film in said defective part.

6. A method for repairing a metallic pattern on a substrate according to claim 5, wherein energy of laser light radiated from a semiconductor laser is used as a heat source for heating said metallic organic compound.

7. A method for repairing a metallic pattern on a substrate



wherein said semiconductor laser unit has an output adjusting unit.